

# The Interaction of Hydrogen and Carbon Monoxide on Polycrystalline Nickel Films at Temperatures up to 353 K

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Received July 1, 1974

The interaction of H<sub>2</sub> and CO on nickel films at 77, 273 and 353 K was investigated by measurements of thermal desorption, electrical resistance and changes in work function. For this purpose the adsorption of H<sub>2</sub> on nickel films partially covered with CO, the adsorption of CO on nickel films partially covered with H<sub>2</sub>, and the alternating adsorption of H<sub>2</sub> and CO were studied.

Although reaction products of H<sub>2</sub> and CO could not be found under the experimental conditions chosen, clear evidence for their interaction could be seen. This interaction could be recognized by an increase in the heat of adsorption of H<sub>2</sub> due to the presence of CO, an increase in the amount of CO adsorbed on nickel films due to the presence of H<sub>2</sub>, and the CO-induced transformation of H<sub>2</sub>, adsorbed in the β<sub>2</sub> phase, into another phase.

## I. INTRODUCTION

For the reaction of H<sub>2</sub> and CO on metal catalysts, the formation of an adduct



has been assumed by different authors (1-4) as a preliminary step which is independent of the reaction products. Several attempts have been made to obtain experimental evidence for the existence of such an intermediate product. Kölbel and his co-workers obtained the first indications of an adsorption complex from calorimetric (5), kinetic (6) and desorption measurements (7) on supported iron catalysts. Infrared absorption bands of a C-OH bond were found on nickel catalysts above 453 K (8).

The discussion of the results, however, was especially difficult when technical catalysts were used and too many parameters may influence the results. There-

fore it is preferable to study the interaction of CO and H<sub>2</sub> on pure metals by means of evaporated films or single crystals, which show better reproducibility. On those materials ir spectra (9), heats of adsorption (10-12), adsorption isotherms (13), flash desorption spectra (14-16), changes in work function (15,17), changes in electrical resistance (12,18), and the sticking probability (19) were measured.

The separate adsorption of H<sub>2</sub> and CO on nickel films has been investigated by measuring the change in electrical resistance (20-25), the work function (25,26), the differential heat of adsorption (20,25,27-30), thermal desorption spectra (31,32), and mass spectra (31-33). Therefore it seemed to be sensible to look for the mutual interaction of H<sub>2</sub> and CO on nickel films by using the same techniques. Reaction products are not very likely at the temperature and pressure conditions chosen (8). The effects observed probably derive from primary interactions between adsorbed H<sub>2</sub> and adsorbed CO.

## II. EXPERIMENTAL METHODS

The experimental methods used are fully described elsewhere (31,33-35).

The glass UHV apparatus gave vacua of  $2 \times 10^{-10}$  Torr. The nickel films were condensed at this pressure on cooled (77 K) glass bulbs at a rate of about 10 Å/min until a thickness of about 100 Å was obtained. Sintering for 1 hr at 333 or 373 K was used to produce films in a more ordered state. They consist then mainly of crystallites which show the (111) and, to a lower extent, the (100) planes on their surfaces (36,37).

CO and H<sub>2</sub> were adsorbed on the films in various sequences. CO was added from ampoules, H<sub>2</sub> from ampoules or from a UHV gas pipette. CO was produced by thermal decomposition of calcium oxalate; H<sub>2</sub> was introduced by diffusion through a palladium tube. In both cases the mass spectrometric analysis showed a purity of more than 99%. The slight contamination of CO was mainly due to H<sub>2</sub> and He; H<sub>2</sub> was contaminated by rare gases.

The measurements of the electrical resistance were made by means of Wheatstone bridge (35), the change in work function was investigated by a retarding-field diode (38), the differential heat of adsorption was determined by calorimetric measurements (20,27,34), and the thermal desorption was measured in the same way as in the system Ni/H<sub>2</sub> (31). The white-hot cathode of the diode can cause atomization or ionization of the gases. To avoid these effects the cathode was only used when the pressure in the gas phase had fallen below  $10^{-7}$  Torr after each gas addition. However, the hot cathode can be used to produce atomic hydrogen for adsorption.

Because of the mass spectrometric analysis it is often better to use deuterium as an adsorbate instead of hydrogen.

## III. THE SYSTEMS Ni/H<sub>2</sub> AND Ni/CO

The systems Ni/H<sub>2</sub> and Ni/CO have already been described in detail. A short

summary of the results is given here. It is advisable to observe the results of the systems consisting only of one adsorbent and one adsorbate as a function of the fraction  $\theta$  of the monolayer coverage (25). The monolayer coverage is defined by the termination of chemisorption, i.e., for instance, when the heat of adsorption drops to very low values. This coverage is a function of the adsorbate and of the roughness of the films. The monolayer H<sub>2</sub> coverage is  $15 \times 10^{14}$  molecules H<sub>2</sub> cm<sup>-2</sup> on nickel films which were sintered at 333 K, and  $10 \times 10^{14}$  molecules H<sub>2</sub> cm<sup>-2</sup> on nickel films which were sintered at 373 K. The value for CO is  $17.5 \times 10^{14}$  molecules CO cm<sup>-2</sup> at both sinter temperatures.

The results obtained with the system Ni/H<sub>2</sub> (20,21,26,28,29,31,39) are listed below.

1. At coverages below half a monolayer H<sub>2</sub> is atomically adsorbed causing an increase in the electrical resistance (20) and in the work function (26) independent of the temperature between 77 and 273 K. The heat of adsorption decreases from 18 to 16 kcal/mole (20,29). H<sub>2</sub> is adsorbed in a uniform state ( $\beta_2$ ) which can be recognized by a pressure maximum at 360 K in the thermal desorption spectrum (31).

2. A further atomic adsorption takes place as the coverage is increased to a monolayer. This adsorption leads to a decrease in the electrical resistance (20,21) and a slight increase in the work function (26). The differential heat of adsorption shows a maximum and then drops to low values at 273 K (20,29). At 77 K the heat of adsorption decreases continuously (20,29). A further peak ( $\beta_1$ ) can be seen in the thermal desorption spectrum at 320 K (31). When the adsorbate has sufficient mobility [above 181 K (39)] both states,  $\beta_1$  and  $\beta_2$ , are interconverted.

3. A coverage of more than one monolayer cannot be achieved above 77 K under the applied pressures ( $p \leq 10^{-2}$  Torr). At 77 K in addition to the effects listed in paragraph 2, a molecular adsorp-

TABLE I  
 SUMMARY OF RESULTS FOR THE SYSTEMS Ni/H<sub>2</sub> AND Ni/CO

Coverage $\theta$	Effect	Ni/H <sub>2</sub>	Refs.	Ni/CO	Refs.
$0 < \theta \leq 0.5$	$\Delta R$	$>0$	(20, 21)	$>0$	(21, 23, 24, 25)
	$\Delta\phi/V$	$0 \rightarrow 0.23$	(26, 43)	$0 \rightarrow 0.9$	(25)
	$q/\text{kcal mole}^{-1}$	$18 \rightarrow 16$	(20, 28, 29)	$30 \rightarrow 25$	(30)
	Desorption peaks	360 K ( $\beta_2$ )	(31)	460 K ( $\beta_2$ )	(32)
$0.5 \leq \theta \leq 1.0$	$\Delta R$	$<0$	(20, 21)	$<0$	(25)
	$\Delta\phi/V$	$0 \rightarrow 0.25$	(26, 43)	$0 \rightarrow 1.4$	(25)
	$q/\text{kcal mole}^{-1}$	$16 \rightarrow <5$	(20, 28, 29)	$25 \rightarrow <5$	(30)
	Desorption peaks	360 K ( $\beta_2$ ), 300 K ( $\beta_1$ )	(31)	460 K ( $\beta_2$ ), 330 K ( $\beta_1$ )	(32)
$\theta > 1.0$	$\Delta R$	$>0$	(20)	$>0$	(25)
	$\Delta\phi/V$	$<0$	(40)	0	(25)
	$q/\text{kcal mole}^{-1}$	$<1$	(41)	—	—
	Desorption peaks	360 K ( $\beta_2$ ), 300 K ( $\beta_1$ ), 90 K ( $\gamma$ )	(31)	460 K ( $\beta_2$ ), 310 K ( $\beta_1$ ), 170 K ( $\gamma$ )	(32)

tion of H<sub>2</sub> takes place, which causes an increase in the electrical resistance (20) and a decrease in the work function (40). The heat of adsorption is smaller than 1 kcal/mole (41); there is a further pressure peak ( $\gamma$ ) at 90 K in the thermal desorption spectrum (31).

Qualitatively the same effects are found for the system Ni/CO (21,25,33); quantitatively there is a tighter bond to the adsorbent, as can be seen in Table 1.

The system Ni/D<sub>2</sub> differs from the system Ni/H<sub>2</sub> only in the heat of adsorption which is 1 kcal/mole higher (28). This causes an insignificant shift of the desorp-

tion peaks to higher temperatures (42,43). Therefore, in the following discussion both H<sub>2</sub> and D<sub>2</sub> will be referred to as hydrogen.

#### IV. COADSORPTION OF H<sub>2</sub> AND CO ON NICKEL FILMS

##### A. Adsorption of H<sub>2</sub> on Nickel Films After PreadSORPTION of CO

###### 1. Adsorption Temperature 77 K

a. Adsorption of molecular H<sub>2</sub>. Figure 1a shows the change in resistivity  $\Delta\rho$  mul-

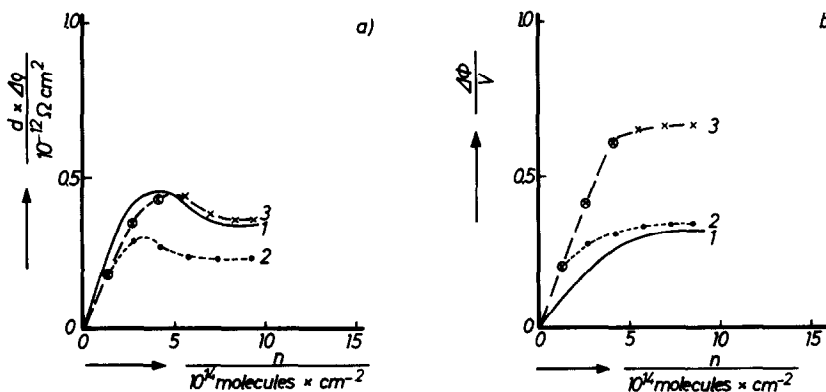


FIG. 1. Influence of H<sub>2</sub> adsorption on the resistivity (a) and the work function (b) of nickel films at 77 K. Precoverage with CO: (1)  $\theta_{CO} = 0$ ; (2)  $\theta_{CO} = 0.15$ ; (3)  $\theta_{CO} = 0.5$ . The encircled points are for CO adsorption.

multiplied by the film thickness  $d$  (22,44) as a function of coverage. The solid line 1 refers to  $H_2$  adsorption on a clean nickel film. After a complete  $H_2$  desorption (cf. line 1 in Fig. 2)  $1.4 \times 10^{14}$  molecules  $CO\ cm^{-2}$ , corresponding to 15% of a monolayer based on  $H_2$ , were adsorbed on the same film. The subsequent  $H_2$  adsorption caused a change in the electrical resistance (cf. line 2 in Fig. 1a) which is qualitatively the same as for a pure  $H_2$  adsorption in this region of coverage (cf. line 1 in Fig. 1a). The quantity of  $CO$  plus  $H_2$  which could be adsorbed is in accordance with the monolayer quantity for a pure  $H_2$  adsorption. The amount of  $H_2$  which was added in the second cycle could again be desorbed completely, whereas the  $CO$  remained on the film at temperatures below 400 K. In a third cycle the  $CO$  precoverage was increased to  $4.1 \times 10^{15}$  molecules  $CO\ cm^{-2}$ , corresponding to about half a monolayer based on  $H_2$ . The following  $H_2$  adsorption led to the same maximum coverage as in cycles 1 and 2. There again no influence of the precoverage was

seen in the qualitative form of the resistance curve.

When the  $CO$  coverage exceeded the monolayer  $H_2$  coverage, no additional  $H_2$  chemisorption could be seen. Horgan and King (19) obtained the same result.

Figure 1b shows the changes in work function which were observed in the three cycles described. It can be seen that the  $CO$  precoverage has only a weak influence on the change in the work function arising from the subsequent  $H_2$  adsorption.

The change in resistivity as well as the change in work function indicate that the  $H_2$  added in the third cycle of the adsorption should exist in a state which is similar to the  $\beta_1$  state of pure  $H_2$  adsorption. But the desorption spectra (cf. Fig. 2) show clearly that the adsorbed  $H_2$  after  $CO$  precoverage (line 3 in Fig. 2) is bound tighter than  $H_2$  in the  $\beta_1$  state adsorbed on a clean nickel film (cf. line 1 in Fig. 2). This indicates an interaction between  $H_2$  and  $CO$ .

*b. Adsorption of atomic hydrogen.* No chemisorption of  $H_2$  molecules could be observed on a  $CO$  layer with a coverage greater than the  $H_2$  monolayer. But a large amount of hydrogen atoms can be adsorbed on this  $CO$  layer. This adsorption causes the work function to decrease proportionally with the coverage, as reported by other authors (17). At the same time the electrical resistance increases. These facts are shown in Fig. 3.

The desorption peak ( $\alpha$ ) of  $H_2$  added as atoms (cf. Fig. 4) clearly differs from the peaks  $\beta_1$  and  $\beta_2$ , which are found after pure  $H_2$  adsorption (31). This peak also differs from the peak of  $H_2$  produced by molecular addition after  $CO$  precoverage (cf. Fig. 2). The desorption maximum ( $\alpha$  in Fig. 4) is approximately at 300 K, which is clearly below other maxima. This desorption temperature is in accordance with the results of Siddiqi and Tompkins (17). They state that 50% of  $H_2$  which was atomically added and adsorbed on a  $CO$  layer at 77 K desorb below 293 K and that the re-

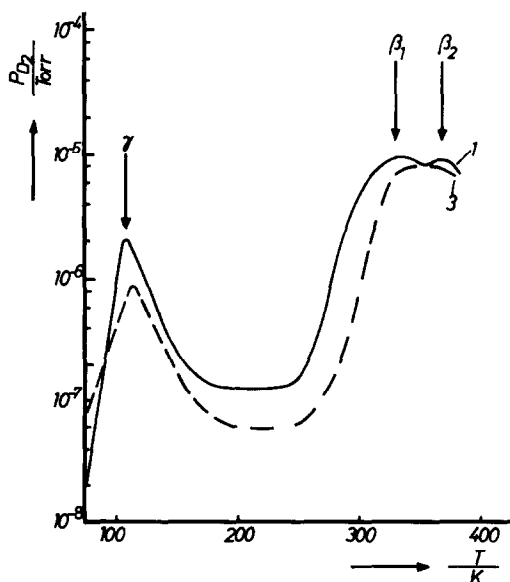


FIG. 2. Thermal desorption of  $H_2$  from nickel films without  $CO$  precoverage (1) and with half monolayer  $CO$  precoverage (3).

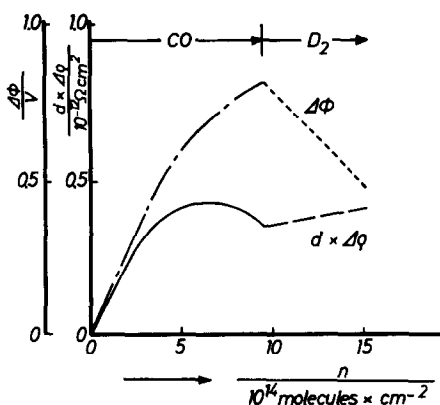


FIG. 3. Influence of the adsorption of atomic hydrogen on the resistivity  $\rho$  and the work function  $\phi$  after a monolayer CO precoverage.

maining H<sub>2</sub> can be removed from the nickel film by pumping for 1 hr. These authors (17) assume that this H<sub>2</sub> exists in a positively polarized state within the chemisorbed CO monolayer.

## 2. Adsorption Temperature 273 K

The change in the electrical resistance at 273 K due to the chemisorption of H<sub>2</sub> on nickel films, which were partly covered

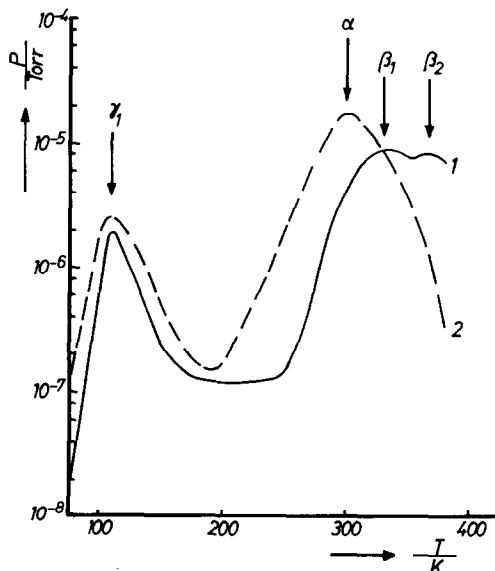


FIG. 4. Thermal desorption of H<sub>2</sub> from nickel films, which was added molecularly, without CO precoverage (1) and thermal desorption of H<sub>2</sub> from nickel films, which was added atomically, after a monolayer CO precoverage (2).

with CO, has already been published (12). These results are in accordance with those at 77 K described in Sect. IV.A.1.a. and shown in Fig. 1a.

From the shift of the desorption peak of H<sub>2</sub> to higher temperatures—caused by the CO precoverage (cf. Fig. 2)—it was concluded that there would be a more tightly bound form of H<sub>2</sub> at 77 K due to the CO precoverage. At 273 K the heats of adsorption of H<sub>2</sub> on nickel films, partly covered with CO, show a clear increase compared with those of a pure H<sub>2</sub> adsorption. As shown in Fig. 5 the increase  $\Delta q$  is about 3–5 kcal/mole. It is especially striking that this difference remains constant over a wide range of coverage even at a low CO precoverage. This is an argument against the formation of a stoichiometric adsorption complex



as mentioned in the literature (4–7), because the amount of H<sub>2</sub> taken up with increased heat of adsorption is more than three times the preadsorbed amount of CO.

When a nickel film is covered with an amount of CO which exceeds the monolayer coverage based on H<sub>2</sub>, a very slow

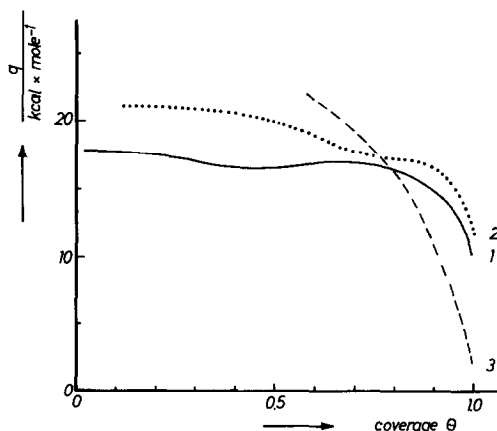


FIG. 5. Differential heat of adsorption  $q$  of H<sub>2</sub> on nickel films at 273 K. Procurement with CO: (1)  $\theta_{\text{CO}} = 0$ ; (2)  $\theta_{\text{CO}} = 0.1$ ; (3)  $\theta_{\text{CO}} = 0.6$ .

H<sub>2</sub> adsorption can be seen at 273 K when H<sub>2</sub> molecules are added. This is in contrast to the case at 77 K and to the statements of Horgan and King (19). This adsorption, which only insignificantly increases the electrical resistance, is reversible, i.e., H<sub>2</sub> can be easily pumped off. From the change in the temperature of the calorimeter it can be concluded that the H<sub>2</sub> adsorption is endothermic. Due to the very slow rate of adsorption a quantitative analysis of the calorimetric data was impossible. By means of work function measurements one might be able to decide whether this state of adsorption is identical to the  $\alpha$  state at 77 K. As a result of the high gas pressure no measurements were possible with the diode.

No displacement of CO by H<sub>2</sub> was observed at 77 and 273 K.

## B. Adsorption of CO on Nickel Films After Precoverage with H<sub>2</sub>

### 1. Adsorption Temperature 77 K

Figure 6 shows the change in resistivity due to the adsorption of H<sub>2</sub> followed by adsorption of CO. H<sub>2</sub> was adsorbed up to

a monolayer; this adsorption was accompanied by the well-known change in resistivity. Then CO was added until a perceptible CO partial pressure could be noticed. The change in resistivity due to this adsorption was quite different from that on a clean film. At first (region I in Fig. 6) the slope of the resistivity curve is gentler than on clean films. At  $n = 6 \times 10^{14}$  molecules CO cm<sup>-2</sup> the curve reaches a point of inflection and at  $22 \times 10^{14}$  molecules CO cm<sup>-2</sup>, when CO showed a noticeable pressure, the change in resistivity reaches a saturation value. This saturation value is about the same as on clean nickel films. The explanation of this change in resistivity is given at the end of paragraph IV.B.2 in connection with similar results at 273 K.

Throughout the whole adsorption of CO at 77 K no H<sub>2</sub> was displaced. The amount of adsorbed CO was about the same as on a clean Ni film at 77 K. Therefore the total amount of adsorbed gas equaled one monolayer of H<sub>2</sub> plus one monolayer of CO.

In a fresh experiment H<sub>2</sub> was first adsorbed to more than a monolayer giving some physically adsorbed H<sub>2</sub> in the  $\gamma$  state in addition to the  $\beta_1$  and  $\beta_2$  states (cf. Table 1). During the following CO adsorp-

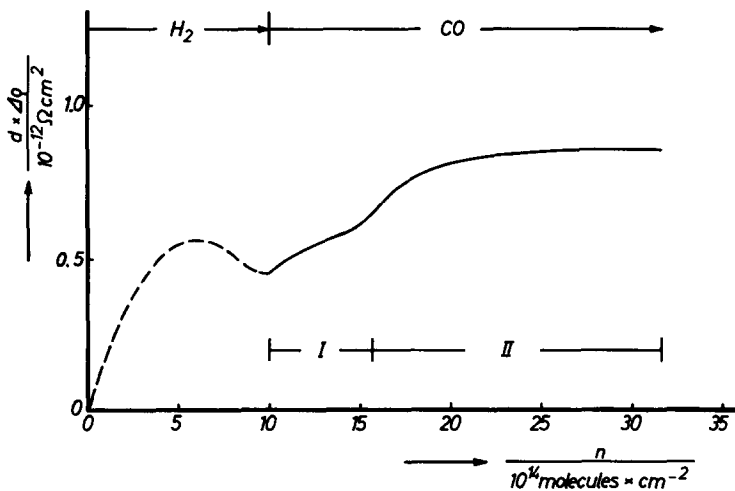


FIG. 6. The change in resistivity  $\Delta\rho$  due to H<sub>2</sub> adsorption (up to  $10 \times 10^{14}$  molecules H<sub>2</sub> cm<sup>-2</sup>) and subsequent CO adsorption. Adsorption temperature 77 K.

tion this physically adsorbed H<sub>2</sub> was displaced immediately into the gas phase.

The observations at 77 K mentioned above are in good agreement with the results obtained by Horgan and King (19).

## 2. Adsorption Temperature 273 K

At 273 K matters become more complicated when a nickel film is first covered with H<sub>2</sub>, and then followed by CO adsorption.

In Fig. 7 the total pressure in the gas phase (---), the partial pressure of H<sub>2</sub> (broken line) and the partial pressure of CO (solid line) are plotted versus coverage. During H<sub>2</sub> adsorption up to  $\theta_{\text{H}_2} \approx 0.5$  the gas phase pressure was only due to helium (dotted line) which had diffused into the H<sub>2</sub> ampoules. It was pumped off. The following CO adsorption did not significantly increase the pressure until the total coverage had reached the monolayer coverage based on H<sub>2</sub>, at  $n = 13 \times 10^{14}$  molecules cm<sup>-2</sup>. The partial pressure analysis indicated mainly H<sub>2</sub>, apart from minor contaminants consisting of methane and helium, which had been in the CO ampoules (33). This H<sub>2</sub> must have been displaced from the film by CO. As soon as

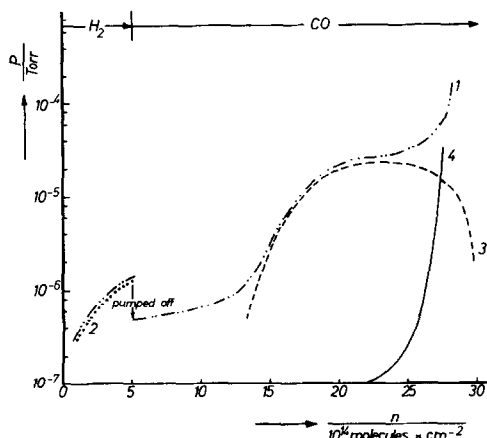


FIG. 7. Analysis of the gas phase during CO adsorption on a nickel film precovered with  $5 \times 10^{14}$  molecules H<sub>2</sub> cm<sup>-2</sup> at 273 K. (1) Total pressure; (2) He partial pressure; (3) H<sub>2</sub> partial pressure; (4) CO partial pressure.

$17 \times 10^{14}$  molecules CO cm<sup>-2</sup> had been adsorbed (corresponding to a monolayer of CO on a clean nickel film), the CO partial pressure in the gas phase rose. Further CO added was hardly adsorbed at all and therefore remained mainly in the gas phase. At the same time the H<sub>2</sub> partial pressure started decreasing again. This effect is identical with the slow H<sub>2</sub> adsorption on a CO monolayer already described in Sect. IV.A.2. No reaction products were observed in the gas phase.

The differential heat of reaction  $q_{\text{CO}}$ , the change in work function  $\Delta\phi$ , and the change in resistivity  $\Delta\rho$  multiplied by the film thickness  $d$  are plotted in Fig. 8 versus the coverage of H<sub>2</sub> and CO. Prior to these measurements the film had been sintered at 373 K and therefore showed a slightly lower capacity for adsorbing gas than the film in Fig. 7. The H<sub>2</sub> coverage was  $\theta_{\text{H}_2} \approx 0.5$ . The arrows  $a$  and  $b$  mark the appearance of H<sub>2</sub> and CO, respectively, in the gas phase (cf. Fig. 7). The effects observed as a result of H<sub>2</sub> adsorption are the usual ones on clean nickel films (cf. Table 1). During the following CO adsorption the change in work function could be measured only until a perceptible equilibrium pressure occurred. The dipole moment,

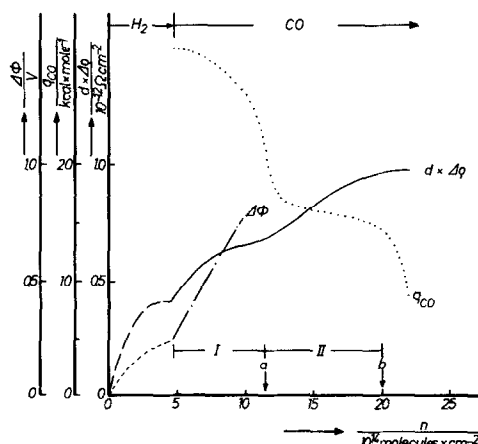


FIG. 8. The change in work function  $\phi$ , resistivity  $\rho$ , and net heat of reaction  $q$  due to CO adsorption on a nickel film (thickness  $d$ ) at 273 K after a H<sub>2</sub> precoverage until  $n = 5 \times 10^{14}$  molecules H<sub>2</sub> cm<sup>-2</sup>.

which can be calculated from the slope, is only 10% lower than for CO adsorption on a clean nickel film.  $q_{CO}$  is the net heat of reaction for all effects accompanying the chemisorption of 1 mole of CO. The value of  $q_{CO}$  initially measured is about the same as for the heat of adsorption of CO on a clean nickel film at low coverage. Then  $q_{CO}$  drops to about 18 kcal/mole. This value has just been reached, when the  $H_2$  partial pressure starts rising noticeably (cf. arrow *a* in Fig. 8). Between the arrows *a* and *b* the  $H_2$  partial pressure increases proportionally to the amount of CO added. The curve of the heat of reaction  $q_{CO}$  in this region shows a plateau with an average value of 16 kcal/mole. When the CO partial pressure starts to rise (cf. arrow *b* in Fig. 8)  $q_{CO}$  has the value of 15 kcal/mole. Then  $q_{CO}$  slumps to low values.

The two sections, CO adsorption without  $H_2$  displacement (until arrow *a*), and CO adsorption with  $H_2$  displacement (*a* to *b*) stand out clearly in the resistivity curve ( $d \times \Delta\rho$ ) in a way which is very similar to that at 77 K.

Before the curves can be discussed in detail the quantity of  $H_2$  displaced by CO should be expressed as a function of the CO coverage. Figure 9 shows this rela-

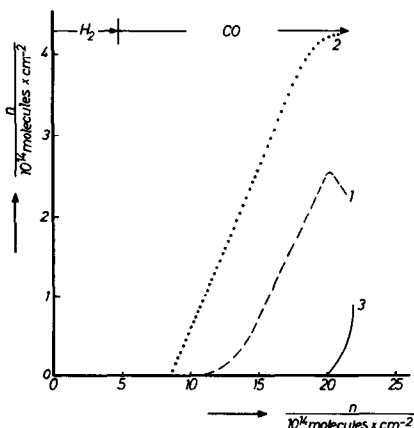


FIG. 9. Displacement of preadsorbed  $H_2$  (molecules  $cm^{-2}$ ) due to a subsequent CO adsorption at 273 K. (1) Displaced amount of  $H_2$  without pumping; (2) displaced amount of  $H_2$  when pumped off; (3) amount of CO not adsorbed.

tionship for two different experiments. Curve 1 was obtained when no gas was pumped off and the mass spectrometric analysis of the gas phase was always made at the same time (10 min after each CO addition). This curve is in accordance with the broken line in Fig. 7. If the displaced  $H_2$  was pumped off immediately after each CO adsorption, in order to prevent the readsorption of displaced  $H_2$ , and the pumped-off gas is collected in a known volume, one obtains curve 2 in Fig. 9 for the amount of  $H_2$  displaced. It is obvious that at the first appearance of a perceptible CO pressure (curve 3 in Fig. 9) the whole of the  $H_2$  originally adsorbed had been displaced from the film.

In order to interpret the effects plotted in Figs. 7 to 9, the following mechanism is taken as a basis for the interaction of the two gases:

1.  $H_2$  is only added up to half a monolayer coverage. Therefore it is adsorbed in the state  $\beta_2$  causing an increase in the electrical resistance (cf. Sect. III).

2. As long as the overall coverage does not exceed the monolayer coverage based on  $H_2$ , the adsorbed CO increases the electrical resistance without displacing  $H_2$  into the gas phase.  $H_2$  originally adsorbed in state  $\beta_2$  changes into another state which leads to a decrease in the electrical resistance. This state might be similar to the  $\beta_1$  state of  $H_2$  adsorbed on a clean nickel film (cf. Table 1).

3. When the total coverage exceeds the monolayer coverage based on  $H_2$ ,  $H_2$  is displaced from the film into the gas phase by CO.

4.  $H_2$  is slowly readsorbed on the CO layer from the gas phase.

In order to interpret the curve of resistivity in Fig. 8 it is advisable to compare it with the change in resistivity which is due to CO adsorption on a clean nickel film. In Fig. 10 these two curves are plotted versus the coverage and, as shown, the same final value of  $d \times \Delta\rho$  has been achieved in both



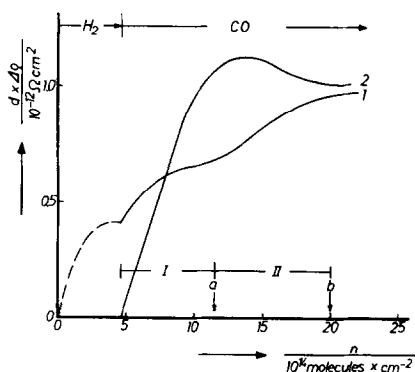


FIG. 10. The change in resistivity  $\Delta\rho$  multiplied by the film thickness  $d$  due to H<sub>2</sub> adsorption ( $\theta = 0.5$ ), followed by CO adsorption (1) and due to pure CO adsorption (2);  $T = 273$  K.

cases; i.e., preadsorption of H<sub>2</sub> followed by CO adsorption which is connected with a displacement of H<sub>2</sub> (line 1) and adsorption of CO on a clean nickel film (line 2).

In region I, i.e., before H<sub>2</sub> is displaced into the gas phase, the change in resistivity due to CO adsorption is less than it would be during a CO adsorption on a clean nickel film.

According to the hypothesis assumed the change in resistivity in this section should be composed of two effects, namely the increase in resistivity due to CO adsorption and the decrease in resistivity caused by the transformation of H<sub>2</sub> from the state  $\beta_2$  into a new state. The expected minor increase in resistivity was in fact observed.

In region II H<sub>2</sub> is displaced and the change in resistivity should again be composed of two effects, namely a slight change in resistivity due to the CO adsorption and an increase in resistivity due to the H<sub>2</sub> displacement. The latter effect can be proved experimentally when, in region II, H<sub>2</sub> is not only displaced (line 1 in Fig. 9) but is also removed by pumping (curve 2 in Fig. 9). The result is shown in Fig. 11: although the CO adsorption only changes the resistance slightly the resistance is then increased by pumping off H<sub>2</sub>. The slight reversal of this effect above  $n = 15 \times$

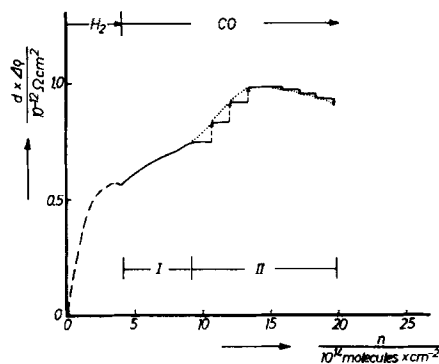


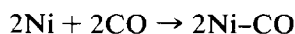
FIG. 11. The change in resistivity  $\Delta\rho$  multiplied by the film thickness  $d$  due to H<sub>2</sub> adsorption ( $\theta = 0.5$ ) followed by CO adsorption. The arrows show the change in resistivity caused by pumping off the displaced H<sub>2</sub>;  $T = 273$  K.

$10^{14}$  molecules  $\text{cm}^{-2}$  remains unexplained.

The plateau in the  $q_{\text{CO}}$  curve plotted in Fig. 8 is situated in region II, where H<sub>2</sub> is displaced from the film by CO. The slope of line 1 in Fig. 9 indicates that about two CO molecules are necessary to displace one H<sub>2</sub> molecule under the experimental conditions chosen.

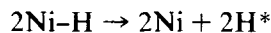
In the first approximation the whole process of displacement can be divided into three steps:

a. adsorption of CO



$$\Delta H = 2\left(-25 \frac{\text{kcal}}{\text{mole CO}}\right);$$

b. breaking of the chemisorption bond Ni-H

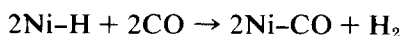


$$\Delta H = 2\left(61 \frac{\text{kcal}}{\text{mole Ni H}}\right);$$

c. recombination of the hydrogen atoms



Therefore the overall reaction,



$$\Delta H = 2\left(-16 \frac{\text{kcal}}{\text{mole CO}}\right),$$

should show a heat of reaction  $q_{\text{CO}} = (-16 \text{ kcal/mole CO})$ . This is in good agreement with the experimental results (cf. Fig. 8).  $\text{H}^*$  stands for a hydrogen atom which is no longer chemisorbed.

After the explanation of the results at 273 K it is now possible to return to the observations at 77 K.

Again the change in resistivity due to  $\text{H}_2$  adsorption and to the subsequent CO adsorption at 77 K (cf. Fig. 6 of Sect. IV.B.1.) can be explained by the transformation of the chemisorbed  $\text{H}_2$ . In region I of Fig. 6  $\beta_2\text{-H}_2$ , which originally increases the resistivity, is transformed by CO into another state, thus producing a smaller overall increase in resistivity than that due to the CO adsorption. In region II of Fig. 6  $\beta_1\text{-H}_2$ , which originally decreases the resistivity, is transformed by the adsorption of CO into another state. This process is reflected by a higher increase in resistivity at the beginning of region II in Fig. 6.

In contrast to 273 K there is no displacement of chemisorbed  $\text{H}_2$  into the gas phase at 77 K. At 273 K hydrogen is mobile on a nickel surface, whereas at 77 K it has no mobility (39). Probably this immobility prevents step c of the mechanism of the hydrogen displacement assumed above, i.e., the recombination of the hydrogen atoms. These hydrogen atoms remain therefore on the nickel surface.

### 3. Adsorption Temperature 353 K

At 353 K it was not possible to achieve the necessary constant temperature for calorimetric measurements. Furthermore the equilibrium pressure was too high for measurements with the diode. Therefore Fig. 12 shows only the change in resistivity. In Fig. 13 the amount of  $\text{H}_2$  displaced from the film and the amount of CO remaining in the gas phase are plotted (same scales as Fig. 9) versus the total coverage. The  $\text{H}_2$  coverage at 353 K reaches only half a monolayer at an equilibrium pressure of  $10^{-6}$  Torr.  $\text{H}_2$  is displaced immediately

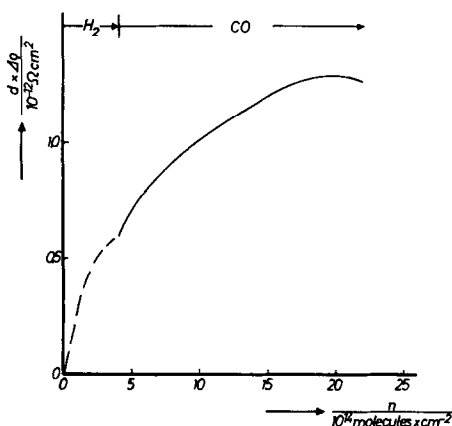


FIG. 12. The change in resistivity  $\Delta\rho$  multiplied by the film thickness  $d$  due to  $\text{H}_2$  adsorption ( $\theta = 0.5$ ) followed by CO adsorption;  $T = 353 \text{ K}$ .

from the film by the following CO adsorption (cf. Fig. 13). Therefore there is no region I in Fig. 13 such as that in Figs. 8, 10 and 11 for adsorption at 273 K. This fact can also clearly be seen in the change in resistivity due to CO adsorption (cf. Fig. 12).

Although  $\text{H}_2$  was very easily displaced from the film at 353 K a re-adsorption of this gas on the CO layer could be observed as at 273 K.

It is striking that the presence of  $\text{H}_2$  doubles the capacity of nickel films for CO uptake at 353 K in comparison with the

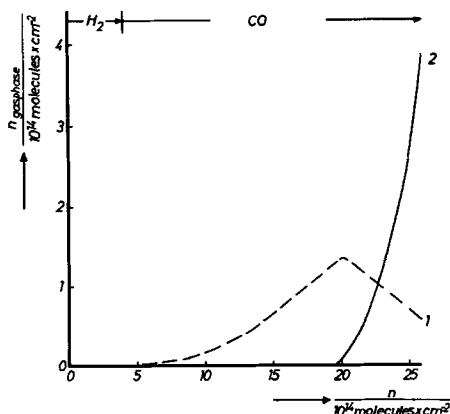


FIG. 13. Displacement of preadsorbed  $\text{H}_2$  due to a following CO adsorption at 353 K. (1) Displaced amount of  $\text{H}_2$  without pumping; (2) the amount of CO in the gas phase.

uptake for CO on clean nickel films. A similar observation was made by Horgan and King at 373 K (19).

### C. Alternating H<sub>2</sub> and CO Adsorption at 273 K

In Figs. 14 and 15 the results of an experiment are shown in which a nickel film was alternately covered with small quantities of H<sub>2</sub> and CO. The arrows *a* and *b*, respectively, indicate at which coverage the H<sub>2</sub> and CO pressure rose.

The two figures sum up the effects which were caused by H<sub>2</sub> adsorption after a CO precoverage (cf. Sect. IV.A) as well as the effects which were caused by CO adsorption after a H<sub>2</sub> precoverage (cf. Sect. IV.B). These are as follows.

The resistivity curves of region I show no mutual interaction of the gases (cf. Fig. 1a). The experiment confirms that at low coverages CO and H<sub>2</sub> adsorption produce the same slope of the resistivity curve.

The increase in the heat of adsorption of H<sub>2</sub> compared with the value achieved on a clean nickel film indicates that there must be an interaction between the two gases (cf. Fig. 5). Whether the heat of adsorption of CO is influenced by H<sub>2</sub> cannot be proved definitely.

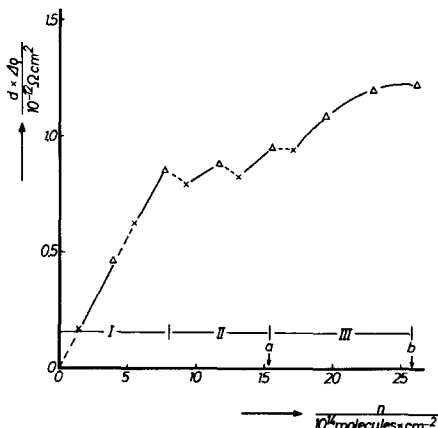


FIG. 14. The change in resistivity  $\Delta\rho$  multiplied by the film thickness  $d$  caused by an alternating H<sub>2</sub> (×) and CO (Δ) adsorption on a nickel film at 273 K. Arrow *a* indicates the coverage at which H<sub>2</sub> appears in the gas phase.

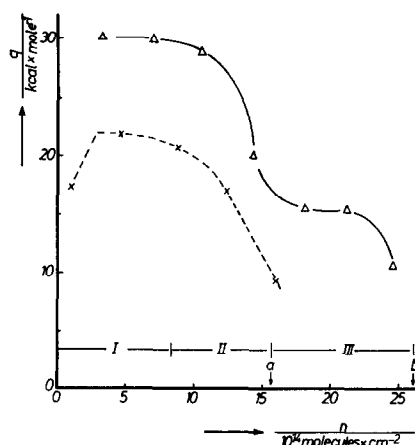


FIG. 15. The differential heat of adsorption during an alternating H<sub>2</sub> (×) and CO (Δ) adsorption on a nickel film at 273 K. Arrow *a* indicates the coverage at which H<sub>2</sub> appears in the gas phase. Arrow *b* indicates the coverage at which CO appears in the gas phase.

In region II the H<sub>2</sub> adsorption leads to a decrease in resistivity, as when H<sub>2</sub> is adsorbed on a clean nickel film beyond half monolayer coverage (cf. Fig. 1a). In the same region the increase in resistivity due to CO adsorption is considerably smaller than on a clean nickel film. This is an indication that H<sub>2</sub> passes from the  $\beta_2$  state into another state (cf. Sect. IV.B.2). The heat of adsorption  $q_{\text{H}_2}$  of H<sub>2</sub> drops to low values, and the net heat of reaction  $q_{\text{CO}}$  of CO falls to the plateau at 16 kcal/mole (cf. Fig. 8).

Finally, in region III, H<sub>2</sub> is displaced by CO into the gas phase. The net heat of reaction  $q_{\text{CO}}$  during this process is about 16 kcal/mole, as it was in Sect. IV.B.2. At the end of region III  $q_{\text{CO}}$  drops to low values and little CO is adsorbed. The change in resistivity in this region is the same as is known from Sect. IV.B.2.

### SUMMARY

No reaction products could be found in the gas phase as a result of the simultaneous adsorption of CO and H<sub>2</sub> on nickel films within the investigated range of temperature of 77 to 353 K. Moreover, there

were no signs of the formation of a reaction product on the surface. This is in agreement with the results of Blyholder and Neff (8), who did not find any reaction products below 453 K when they investigated the interaction of CO and H<sub>2</sub> on nickel/silica catalysts by means of ir measurements.

Despite this, a series of results indicate a considerable interaction between the two gases:

1. The heat of adsorption of H<sub>2</sub> is increased by the presence of preadsorbed CO.

2. H<sub>2</sub> is re-adsorbed on a CO layer at 273 K and higher temperatures.

3. The capacity of the films for CO uptake is considerably increased at 353 K by the presence of H<sub>2</sub>. Horgan and King (19) reported such an effect at 300 K. At 273 K, however, this effect cannot be seen.

The other effects reported can be traced back to the fact that CO is more strongly adsorbed on nickel than H<sub>2</sub>:

1. CO can change H<sub>2</sub> from the  $\beta_2$  state into another adsorbed state, when the total coverage exceeds half monolayer coverage based on H<sub>2</sub>.

2. When the total coverage exceeds the monolayer coverage based on H<sub>2</sub>, H<sub>2</sub> is displaced into the gas phase by CO. Lapujoulade (16) obtained similar results by means of kinetic experiments.

#### ACKNOWLEDGMENTS

The authors are indebted to the Deutsche Forschungsgemeinschaft and the Verband der chemischen Industrie for the financial support of this work.

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